

7 A Active EMI Filter SIP for 24 Vdc Bus

Description:

The QPI-3 active EMI filter attenuates conducted common-mode (CM) and differential-mode (DM) noise over the CISPR22 frequency range of 150 kHz to 30 MHz. The product is designed for use on 24 Vdc bus (10 – 40 Vdc) systems, with 100 Vdc surge capability. The QPI-3's 7 A rating supports multiple DC-DC converter loads up to an ambient temperature of 110°C without de-rating. Designed for the telecom and ITE bus range, the QPI-3 supports the PICMG® 3.0 specification for filtering system boards to the EN55022 Class B limits.

In comparison to passive solutions, the use of active filtering reduces the volume of the common-mode choke, providing a low profile, surface mount device. Smaller size saves valuable board real estate and the reduced height enhances airflow in blade applications.

The QPI-3 is available as a lidded or an open-frame SiP (System-in-Package) with LGA mounting. Evaluation boards are available to allow for quick in-circuit testing of the QPI-3LZ within an existing system design.



Figure 1 - QPI-3LZ
(~1 in² area)

Features:

- 65 dB CM attenuation at 250 KHz (50Ω)
- 80 dB DM attenuation at 250 KHz (50Ω)
- 40 Vdc (max input)
- 100 Vdc surge 100 ms
- 707 Vdc hipot hold off to shield plane
- 7 A rating
- 25.3 x 25.3 x 5.2 mm Lidded SiP (System-in-Package)
- 24.9 x 24.9 x 4.4 mm Open-frame SiP
- Low profile LGA package
- -40° to +125°C Ambient temperature (see Figure 10)
- Efficiency >99%
- Connect in series for higher attenuation
- TÜV Certified

Applications

- Industrial bus supplies
- Telecom base stations
- IBA & distributed power
- COTS systems

Typical Application:

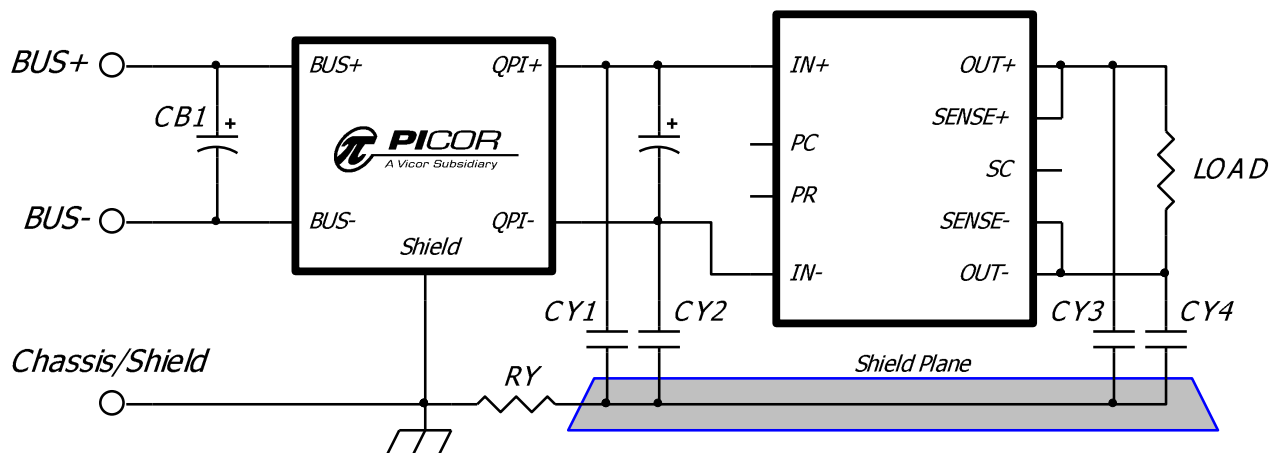


Figure 2 – Typical QPI-3 application schematic with a Vicor brick converter.⁽¹⁾

Note 1: CB1 capacitor, referenced in all schematics, is a 47uF electrolytic; United Chemi-Con EMVE101ARA470MKE0S or equivalent.

CY1 to CY4, referenced in all schematics, are 4.7nF hi-voltage safety capacitors; Vishay VY1472M63Y5UQ63V0 or equivalent.

CIN is the manufacturer's recommended value for input capacitor.

Absolute Maximum Ratings – Exceeding these parameters may result in permanent damage to the product.

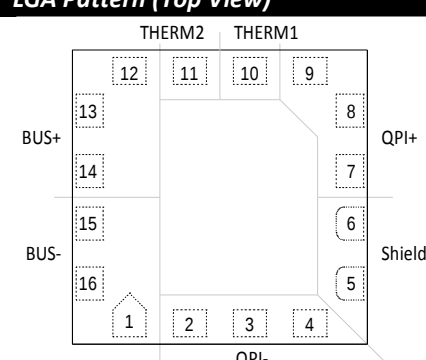
Input Voltage, BUS+ to BUS-, continuous	-40 to 40 Vdc
Input Voltage, BUS+ to BUS-, 100ms transient	-100 to 100 Vdc
BUS+/ BUS- to Shield pads, hi-pot	-707 to 707 Vdc
Input to output current, continuous @ 25°C T _A	7 Adc
Input to output current, 10 seconds @ 25°C T _A	10 Adc
Power dissipation, @ 110°C T _A , 7 A ⁽²⁾	1.3 W
Operating temperature - T _A	-40 to 125 °C
Thermal resistance ⁽²⁾ - R _{θJA} using PCB layout in Figure 22	20 °C/W
Thermal resistance ⁽²⁾ - R _{θPCB}	8 °C/W
Storage temperature, JEDEC Standard J-STD-033B	-55 to 125 °C
Reflow temperature, 20 s exposure	245 °C
ESD, Human body model (HBM)	-2000 to 2000 V

Electrical Characteristics – Parameter limits apply over the operating temp. range unless otherwise noted.

Parameter	Notes	Min	Typ	Max	Units
BUS+ to BUS- input range	Measured at 7 A, 110°C ambient temperature ⁽²⁾	10		40	Vdc
BUS+ to QPI+ voltage drop	Measured at 7 A, 110°C ambient temperature ⁽²⁾			140	mVdc
BUS- to QPI- voltage drop	Measured at 7 A, 110°C ambient temperature ⁽²⁾			37	mVdc
Common mode attenuation	VBUS = 28 V, Frequency = 250 KHz, line impedance = 50Ω		65		dB
Differential mode attenuation	VBUS = 28 V, Frequency = 250 KHz, line impedance = 50Ω		80		dB
Input bias current at 40 V	Input current from BUS+ to BUS-		8		mA

Note 2: See Figure 10 for the current de-rating curve.

Pad Descriptions

Pad Number	Name	Description	LGA Pattern (Top View)
12, 13, 14	BUS+	Positive bus potential	
1, 15, 16	BUS-	Negative bus potential	
7, 8, 9	QPI+	Positive input to the converter	
2, 3, 4	QPI-	Negative input to the converter	
5, 6	Shield	Shield connects to the system chassis or to a safety ground.	
10	THERM1	These pads are electrically connected to the internal circuitry of the QPI-3. THERM1 and THERM2 must be connected to electrically isolated copper for best thermal performance. They cannot be connected to each other.	
11	THERM2		

Ordering Information

Part Number	Description
QPI-3LZ ⁽³⁾	QPI-3 LGA Package, RoHS Compliant
QPI-3LZ-01	QPI-3 LGA Package, RoHS Compliant, Open Frame Package

Note 3: QPI-3LZ is a non-hermetically sealed package. Please read the "Post Solder Cleaning" section on page 12.

QPI-3 Evaluation Boards	
Part #	Description:
QPI-3-EVAL1	A QPI-3LZ mounted on a small evaluation board with screw terminal blocks to allow for easy connection into an existing system.
QPI-3-CB1	A QPI-3LZ mounted on a carrier board designed for use with DOSA compliant footprint dc-dc converters. Screw terminal blocks to allow for easy connection into an existing system.

EMI Management

The more effectively EMI is managed at the source, namely the power converter, the less EMI attenuation the filter will have to do. The addition of “Y” capacitors to the input and output power nodes of the converter will help to limit the amount of EMI that will propagate to the input source.

favor one topology versus another. The EMI generated by the “base-plate” configuration is much greater than that generated by the “open-frame”. Selecting the right topology will greatly reduce the amount of EMI signal that needs to be filtered.

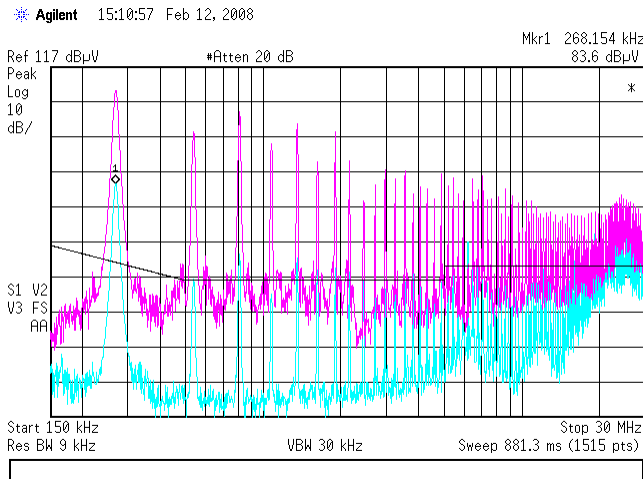


Figure 4 – An unfiltered converter’s response to “open-frame” (light blue) and “base-plate” (purple) EMI configurations.

There are two basic topologies for the connection of the re-circulating “Y” capacitors, referred to as “open-frame” and “base-plate”. Figure 4 illustrates how a converter can

Figure 2 shows the base-plate topology of re-circulating “Y” caps. Here, CY1 to CY4 are connected to each power node of the dc-dc converter, and then are commoned together on a copper shield plane created under the converter. The addition of the copper shield plane helps in the containment of the radiated EMI, converting it back to conducted EMI and shunting it back to its source.

The RY resistor, connected between the shield plane and the QPI’s shield pin, provides an impedance that makes the QPI’s common mode noise cancellation signal more effective at removing the common mode noise that would normally return to the shield/earth connection. It is important when laying out the QPI that the RY resistor connects to the QPI’s shield pin before making the connection to earth ground.

In Figure 5, the open-frame topology is shown where the “Y” capacitors (CY1 and CY2) re-circulate the EMI signals between the positive input and output, and the negative input and output nodes of the power conversion stage.

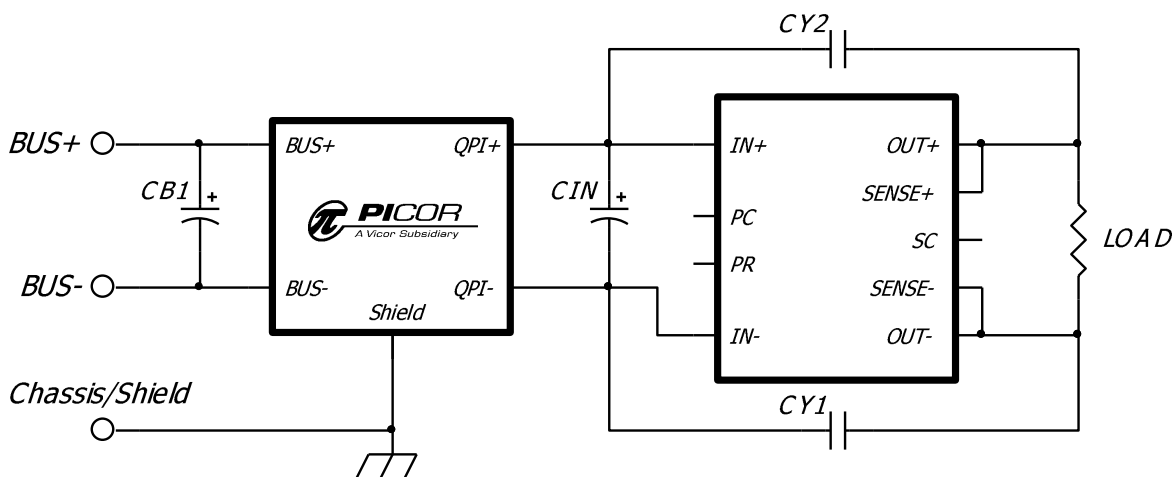


Figure 5 - Typical 'open-frame' application.

Attenuation Test Setups:

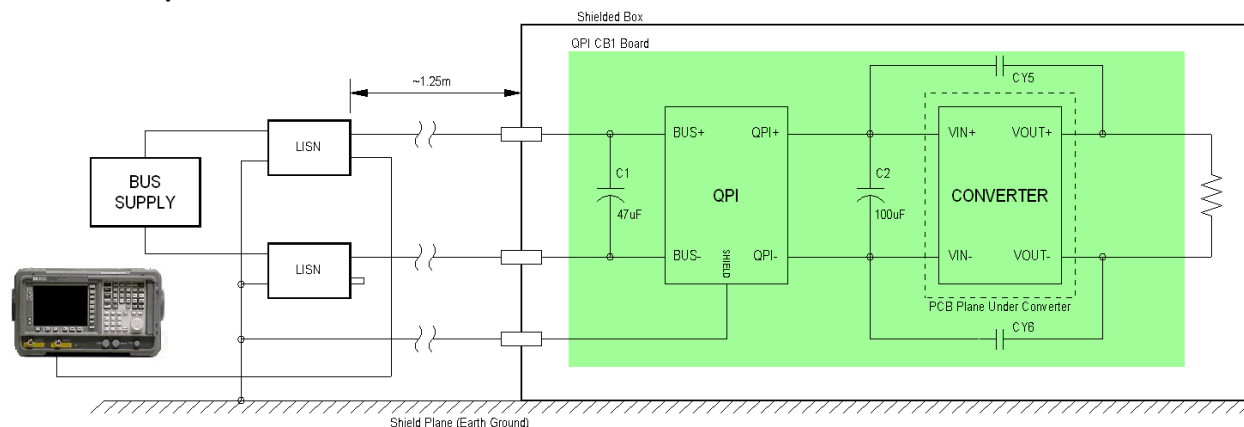


Figure 6 - Open-frame EMI test setup using the QPI-3-CB1 carrier board with 24V converter.

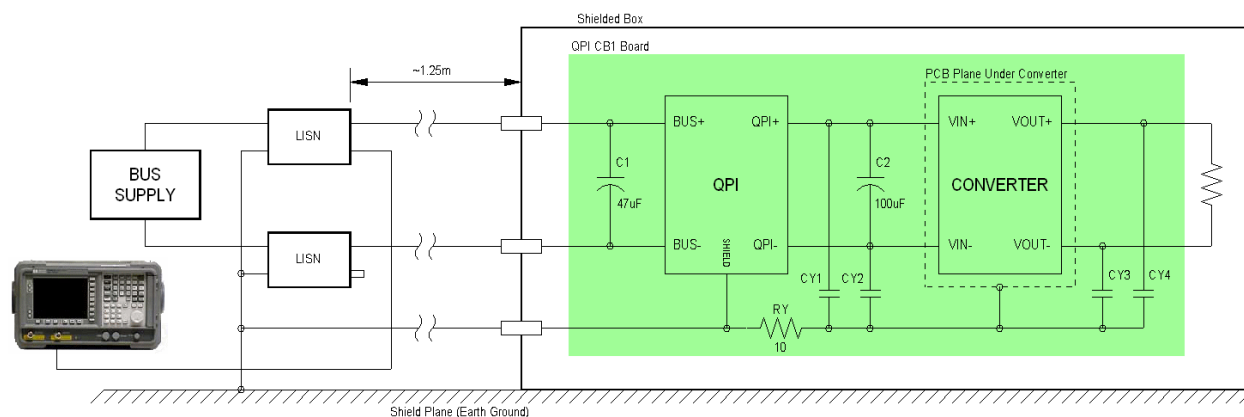


Figure 7 - Base-plate EMI test setup using the QPI-3-CB1 carrier board with 24V converter.

In Figures 6 and 7, C1 is the required 47uF capacitor (United Chemi-Con EMVE101ARA470MKE0S or equivalent), C2 is a converter input cap (value dependant on converter), and CY

caps are 4.7nF ceramic (Murata GRM31BR73A472KW01L or equivalent).

Attenuation Plots: Total EMI noise in base-plate configuration, tested as shown in Figure 7.

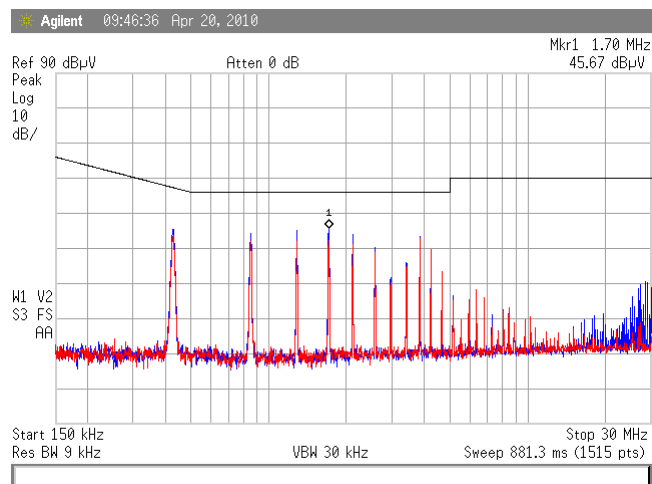


Figure 8 – V24B24C200BG using base-plate “Y” capacitors with a 144W load.

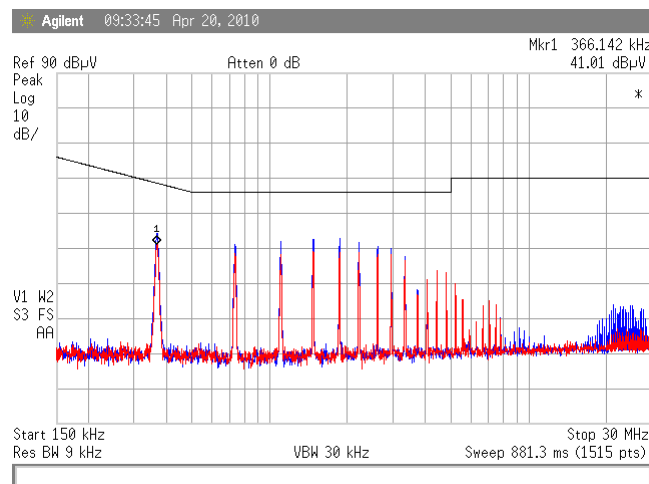


Figure 9 – V24B12C200BN using base-plate “Y” capacitors with a 115W load.

Current De-Rating: mounted to QPI-3-EVAL1 evaluation board.

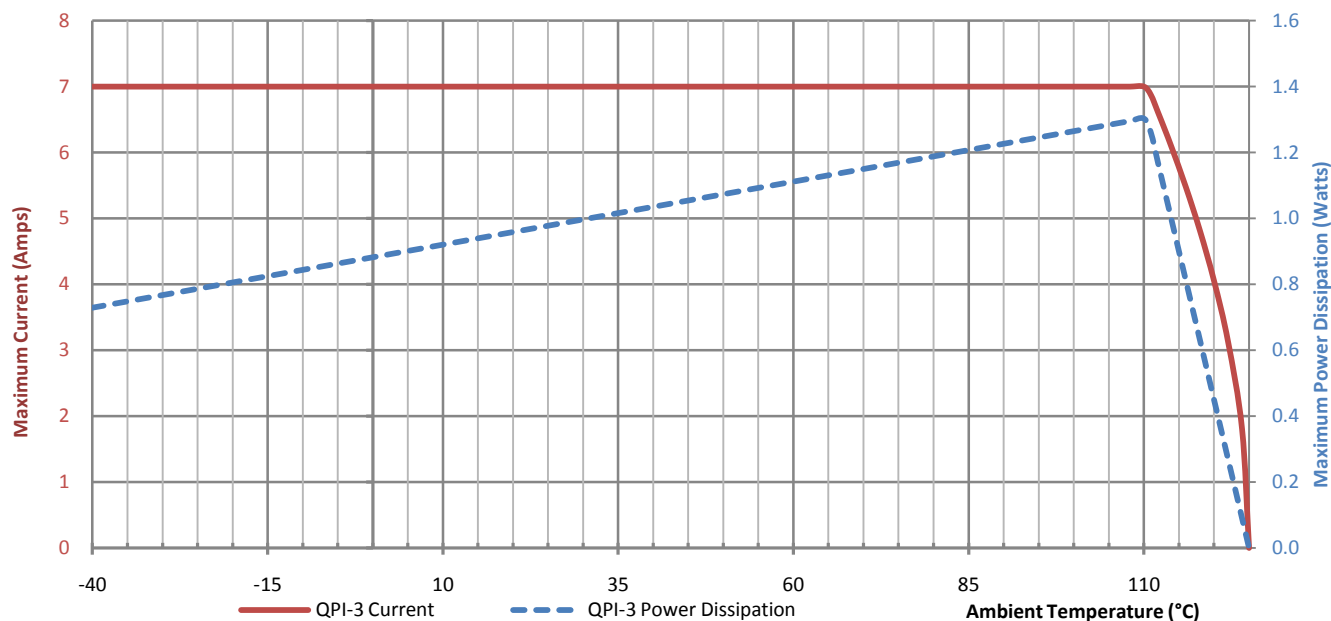


Figure 10 - Current de-rating and power dissipation over ambient temperature range.

The de-rating curve in Figure 10 is based on the maximum allowable internal component temperature and the 7 A maximum rating of the QPI-3. The power dissipation curve is based on the current squared multiplied by the internal

resistance between the inputs and outputs of the filter. The internal resistance value is temperature compensated for the power dissipation curve. The left axis is in amps for the solid trace, the right axis is in watts for the dashed trace.

QPI Application Circuits:

Filtering Dual Converters

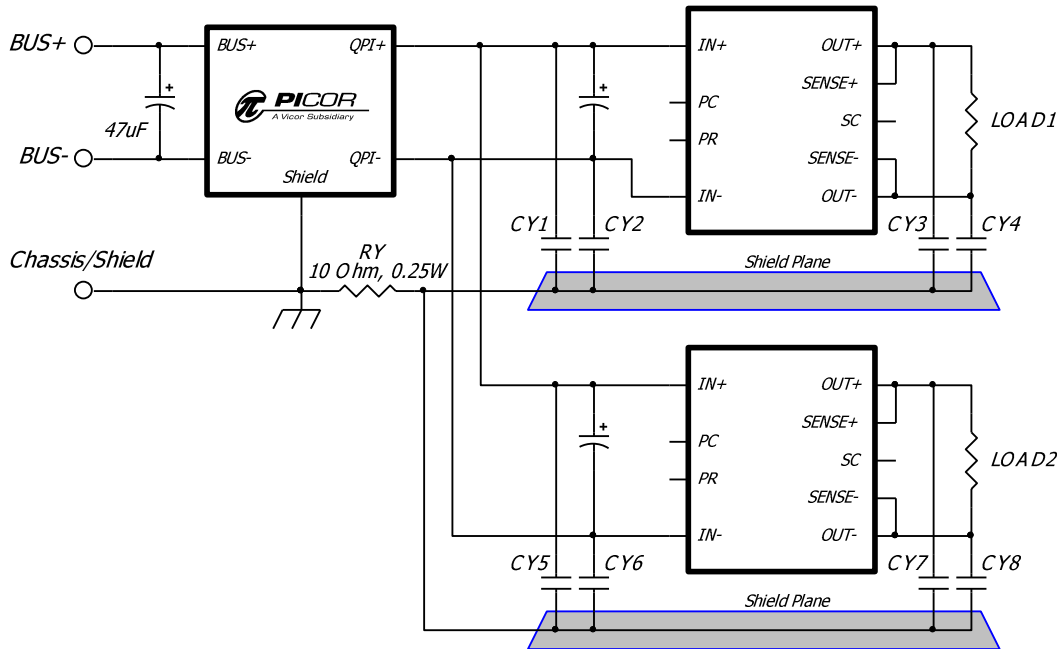


Figure 11 – The QPI-3 filtering dual supplies, using a single RY resistor. ⁽⁴⁾

The shield plane under the two converters in Figure 11 should be one contiguous plane under both. The circuit in Figure 11 is capable of filtering more converters than shown, up to the maximum current capability of the QPI-3. In Figure 12, a separate shield plane is required for each converter along with

a separate RY resistor.

The QPI-3 is not designed to be used in parallel with another QPI-3 to achieve a higher current rating, but it can be used multiple times within a system design.

Filtering Parallel Converters

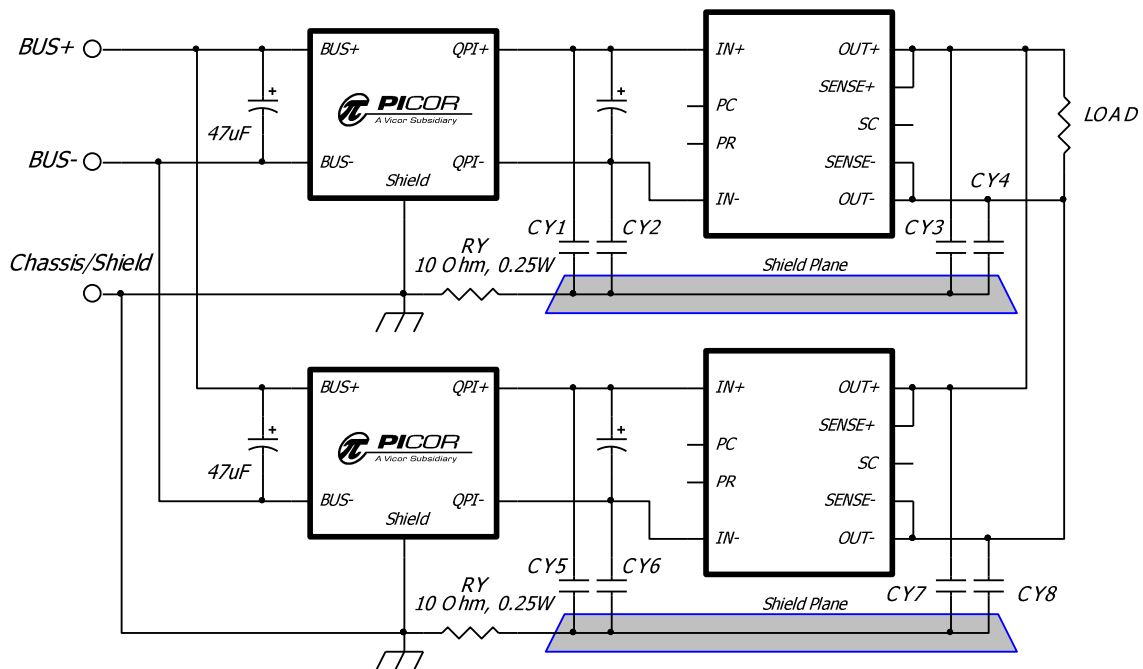


Figure 12 – Dual QPI-3's filtering paralleled converters feeding a common load. ⁽⁴⁾

Note 4: In Figures 11 and 12; CIN1 and CIN2, CY1 through CY8, should be the value and voltage rating recommended by the converter's manufacturer.

Output to Chassis Connection Using the QPI-3

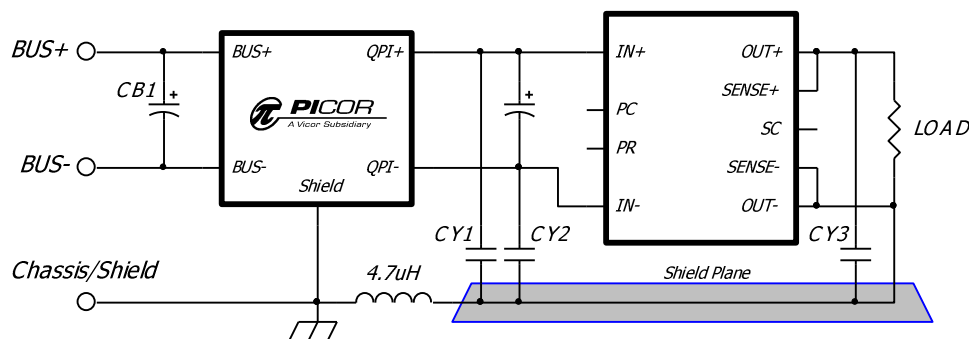


Figure 13 – Connecting the converter's output ground to chassis through an inductor. ⁽⁵⁾

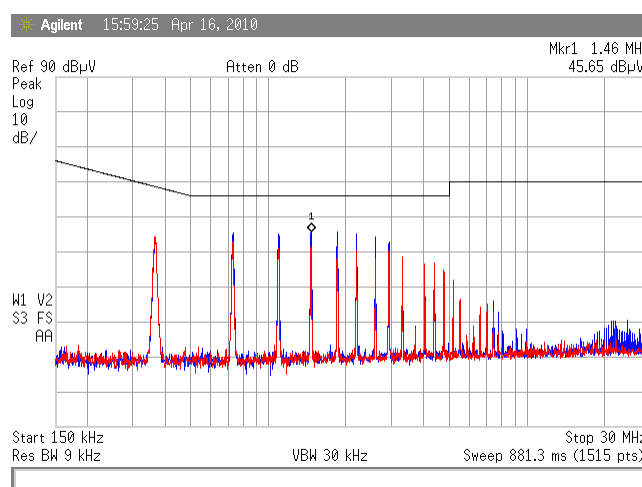


Figure 14 -Total Noise V24B12C200BN with a 136W load, connected as shown in Figure 13

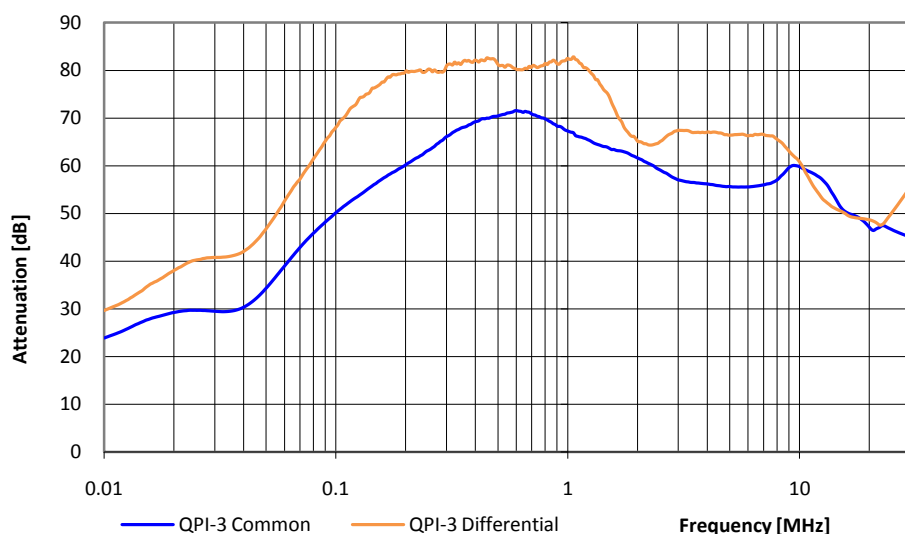
The direct connection of the converter's output to the earth/chassis will degrade the EMI attenuation performance of the QPI-3. Picor recommends that the connection to the earth be made through a series inductor, rated to the maximum output current of the converter, as shown in Figure 13. The EMI plot shown in Figure 14 is of the same converter as in

Figure 8, but uses an inductor in place of RY and has the converter's output ground connected to the shield plane.

The connection of the shield plane directly to the chassis/earth will also degrade EMI attenuation by the QPI-3 and is therefore not recommended.

Note 5: In Figure 13; CIN, CY1 through CY3, should be the value and voltage rating recommended by the converter's manufacturer.

QPI Insertion Loss Measurements



QPI Insertion Loss Equation:

$$\text{Insertion Loss} = 20 * \log * \left[\frac{I_{INA}}{I_{INB}} \right]$$

Figure 15 - Attenuation curves into a 50Ω line impedance, bias from a 28V bus.

QPI Insertion Loss Test Circuits

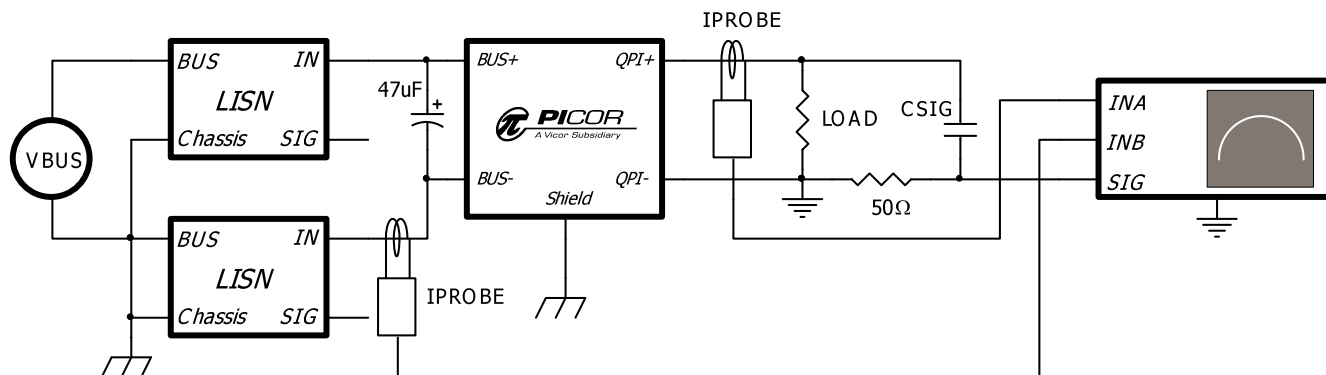


Figure 16 – Test Set-up to measure Differential Mode EMI currents in Figure 15.

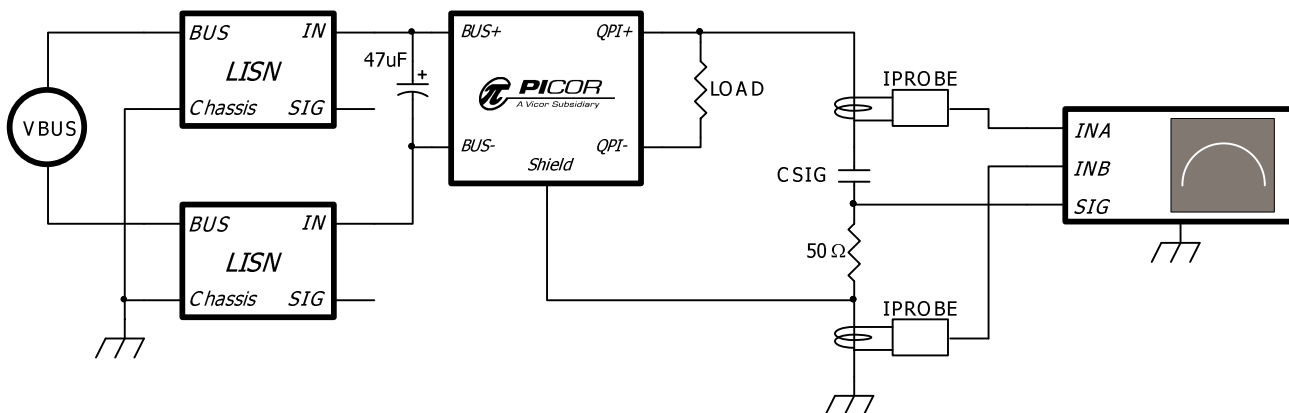


Figure 17 - Test Set-up to measure Common Mode EMI currents in Figure 15.

Mechanicals

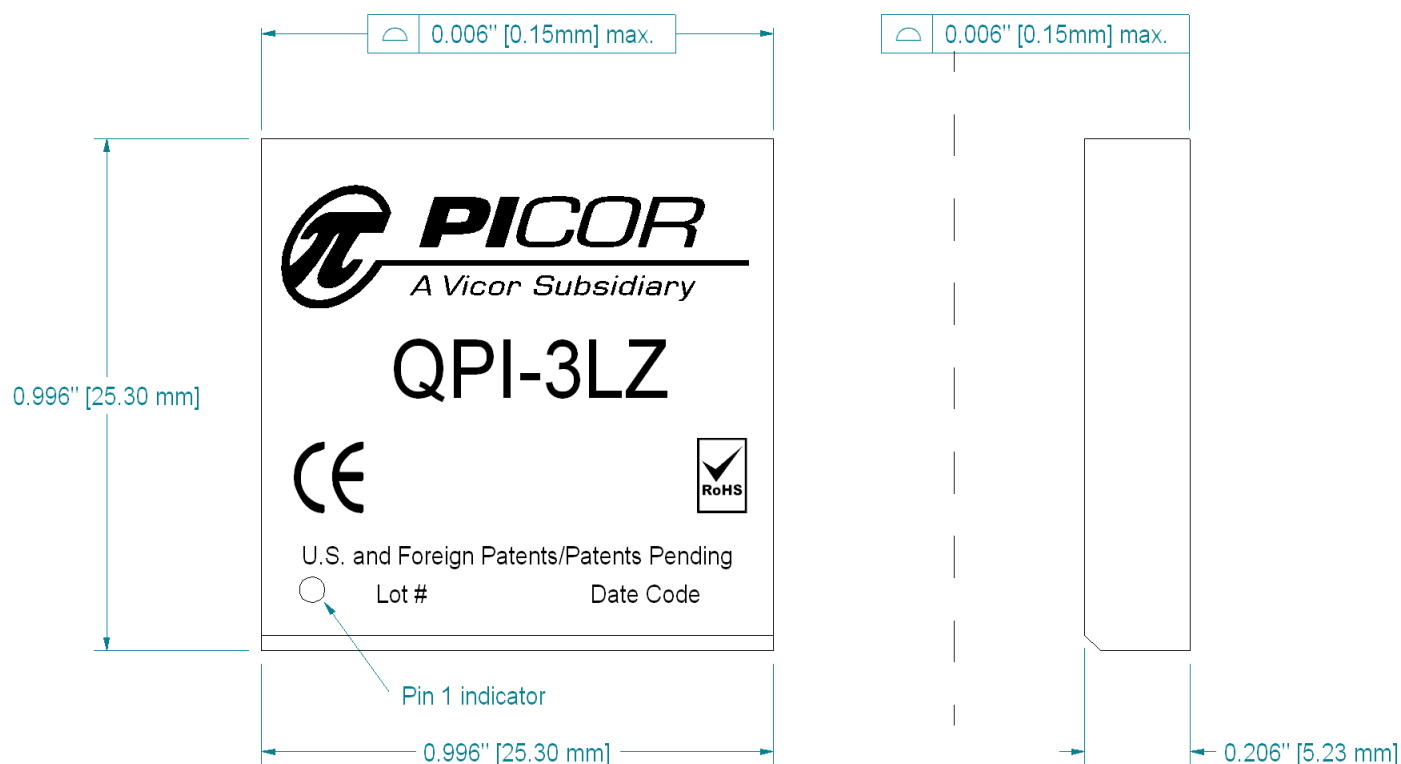


Figure 18 - Lidded Package Dimensions, tolerance of ± 0.004 "

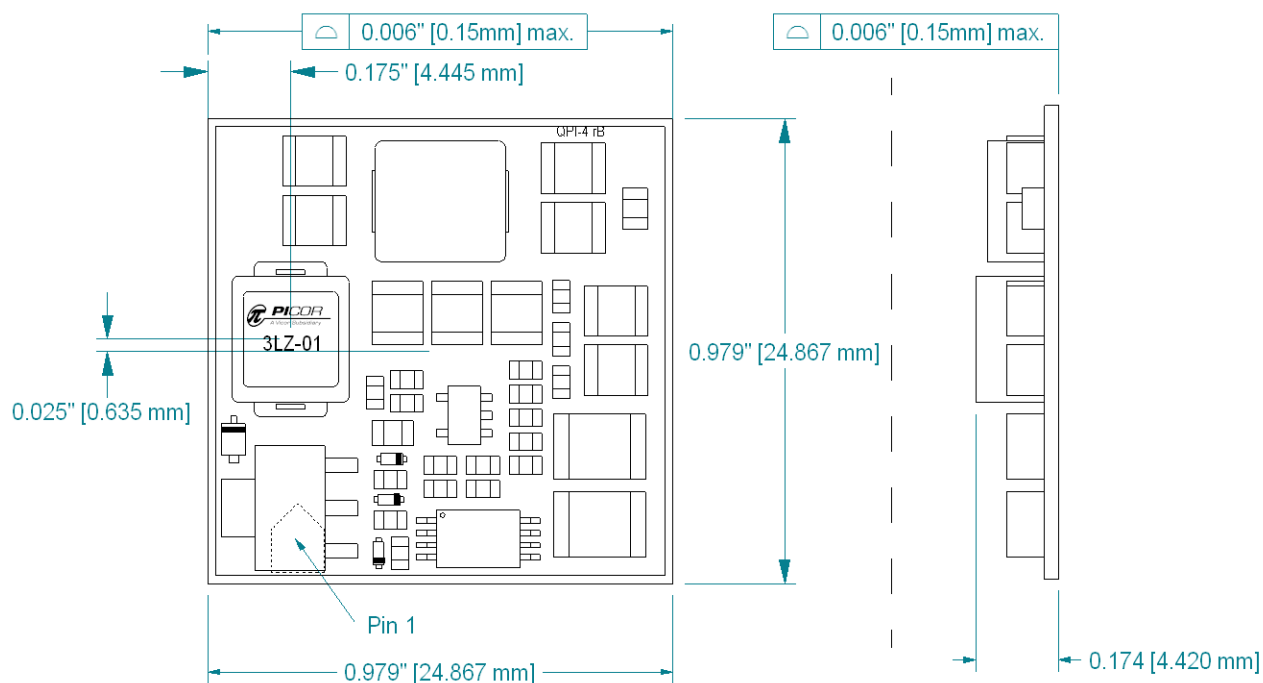


Figure 19 - Open-frame Package dimensions, tolerance of ± 0.004 ". Pick and Place from label center.

Pad and Stencil Definitions:

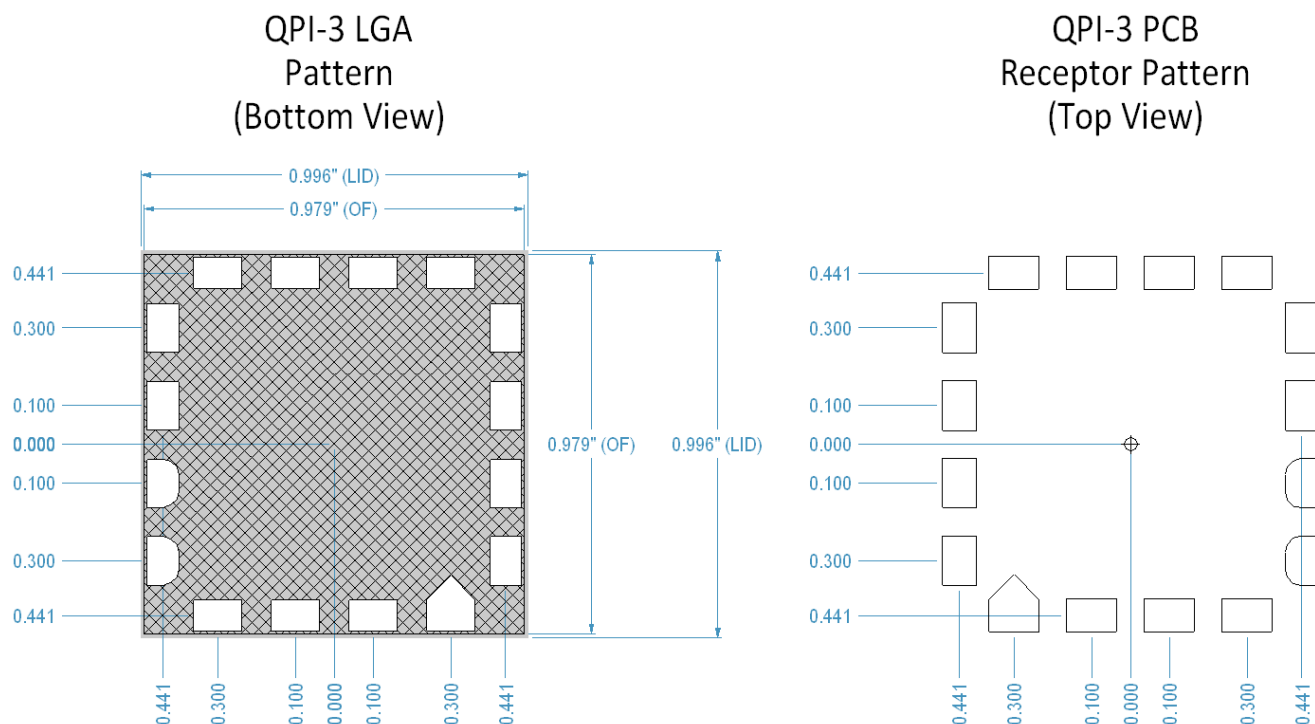


Figure 20 - Bottom view of open-frame (OF) and lidded (LID) products. (All dimensions are in inches.)

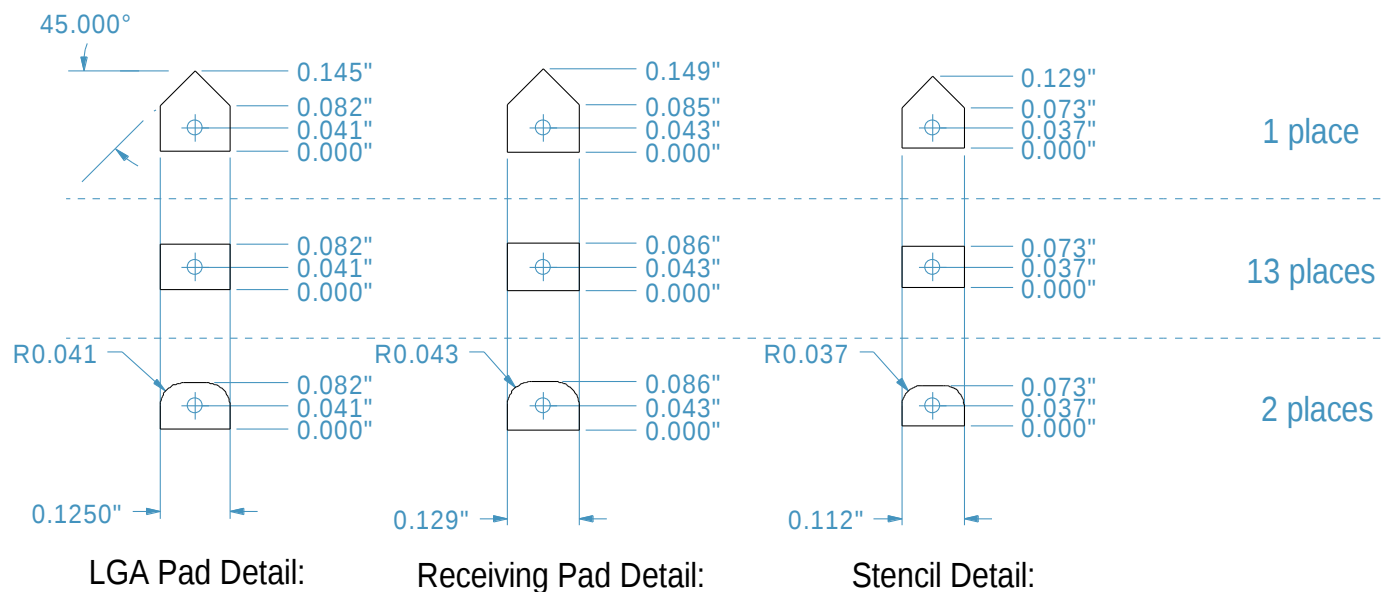


Figure 21 - Recommended receptor and stencil patterns. (All dimensions are in inches.)

Stencil definition is based on a 6mil stencil thickness, 80% of LGA pad area coverage. LGA Package dimensions are for both the Open-Frame and Lidded versions of the QPI-3.

QPI-3 PCB Layout Recommendations:

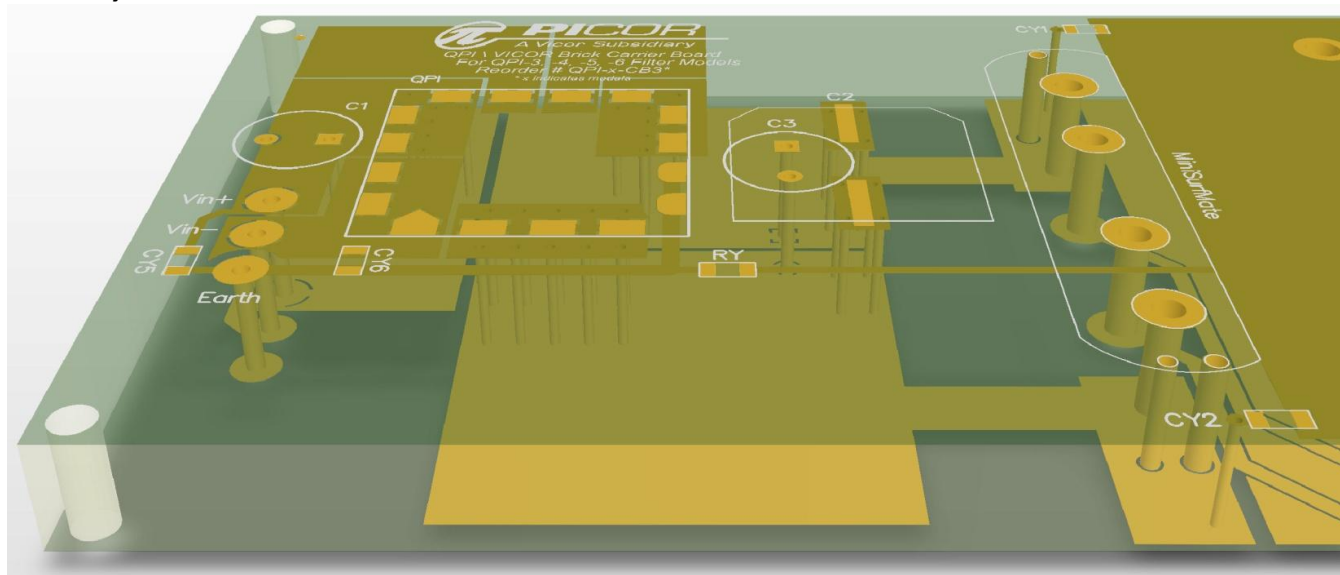


Figure 22 - 3D view of paralleling planes underneath the QPI-3.

PCB Layout

When laying out the QPI-3 EMI filter it is important for the designer to be aware of the radiated EMI field that all converters emit and to place the QPI-3 outside of this field area. It is also recommended that the bus lines feeding into the QPI filter are not routed such that they lie between the QPI and the converter, or that their copper planes over-lap on inner layers. This can cause EMI noise to be coupled from input to output via the parasitic capacitance between the planes.

In Figure 22, the QPI-3 is located ~1.5 inches from the converter's input pins, and the BUS voltage pins are located on the side farthest away from the converter, to keep the radiated EMI from by-passing the filter and coupling directly to the BUS feeds.

Post Solder Cleaning

Picor's LZ version QP SIPs are not hermetically sealed and must not be exposed to liquid, including but not limited to cleaning solvents, aqueous washing solutions or pressurized sprays. When soldering, it is recommended that no-clean flux solder be used, as this will ensure that potentially corrosive mobile ions will not remain on, around, or under the module following the soldering process. For applications where the end product must be cleaned in a liquid solvent, Picor recommends using the QPI-3LZ-01, open-frame version of the EMI filter.

QPI-3 Mechanical Data

Datum	Units	QPI-3LZ	QPI-3LZ-01	Notes
FITS	Failure/Billion Hrs.	209	209	FITS based on the BellCore Standard TR-332
MTBF	Million Hrs.	4.78	4.78	MTBFs based on the BellCore Standard TR-332
Weight	grams	4.3	2.0	
MSL		3	3	
Peak reflow Temperature	°C/20 seconds	245	245	IPC/JEDEC J-STD-020D

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